

ELECTRICAL CIRCUIT MD1+ 1 0--0 J1 MX1+ _____J2 MX1-MD1- 2 o-1:1 • J3 MX2+ MD2+ 3 0-С Ρ A B L E C B MD2- 4 o--o J6 MX2-1:1 o ją MX3+ S MD3+ 5 아 S I D E Ď MD3-6 0--o J5 MX3-Е 1:1 MD4+ 7 0-• J7 MX4+ MD4-8 o -o J8 MX4-1:1 9 o-**\$75 \$**75 **\$75** 75 1nF Forward Forward Voltage(VF) Dominant Wavelength Color ±2kv Current(IF) 10 o GREEN 20mA 2.2V TYP 570 nm TYP GREEN 20mA 2.2V TYP 570 nm TYP GREEN GREEN (14). \rightarrow (12) \sim (13) (11 LEFT LED2 &LED4 **RIGHT LED1&LED3** ELECTRICAL SPECIFICATIONS @25 °C UNLESS OTHERWISE NOTED: Insertion Loss: 1-100MHZ -1.0dB MAX Crosstalk: 1-30MHZ -40.0dB MIN Return Loss: 1-30MHZ -20.0dB MIN 30-60MHZ -35.0dB MIN 60-100MHZ -30.0dB MIN 30-60MHZ -16.0dB MIN CMR: 1-100MHZ -30.0dB MIN 60-80MHZ -12.0dB MIN 100-150MHZ -20.0dB MIN 80-100MHZ -10.0dB MIN Dielectric rating:1500VAC 60s 0.5mA OCL:350uH MIN @ 100KHZ 100mV 8mA DC DCR: 1.2m oHms Dimensions:mm Approved By: TSLEE Unless otherwise specified, all tolerances are \pm 0,25 ABS. REV.

1G BASE-T,Stacked Shielded, LEDs

Technology & Value

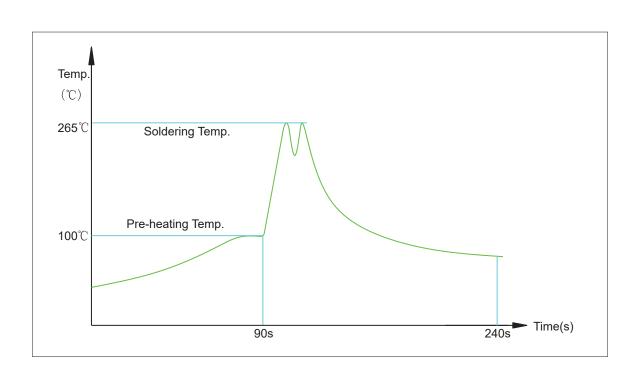
Drafted by:ZhangXuan

Part No: WRJ-G421004NL

SHEET 2 OF 4

А

Suggested Profile of Wave Solder for RoHS products



- 1. Maximum soldering temperature: 265°C
- 2. Maximum soldering time: 5 seconds
- 3. SnAgCu or SAC, melting point is 219 $^{\rm o}{\rm C}$
- 4. Any plastic components located under the Printed Circuit Board / Printed Wiring Board surface might be very slightly melted by recommended temperature profile. It will however, not affect the connector function. (For example, the plastic pins of the connector)

LABS Technology & Value	Dimensions:mm Unless otherwise specified, all tolerances are \pm 0,25	Approved By: TSLEE		
	1G BASE-T,Stacked Shielded, LEDs	Part No: WRJ-G421004NL		REV. A
Drafted by:ZhangXuan			SHEET 3 (OF 4

